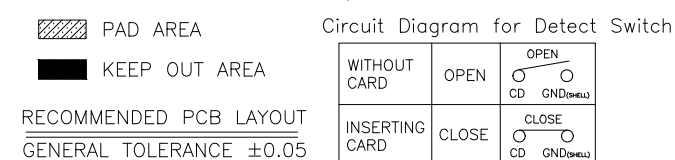
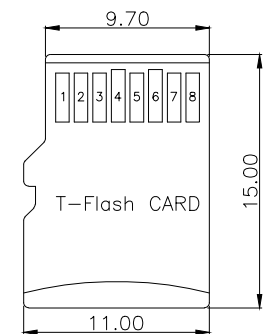
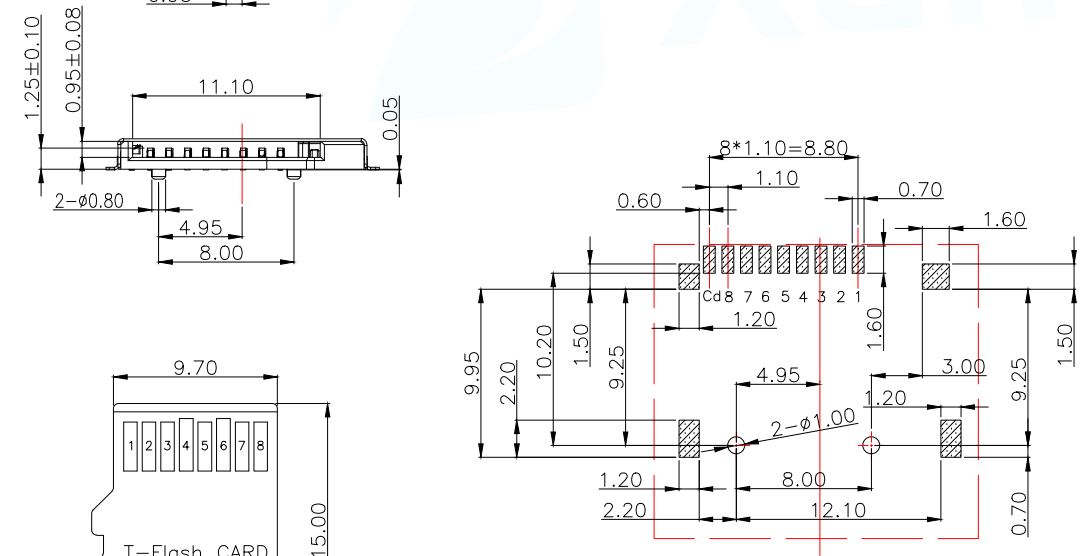
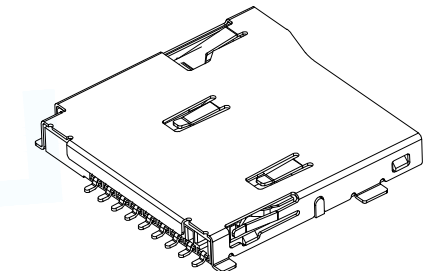


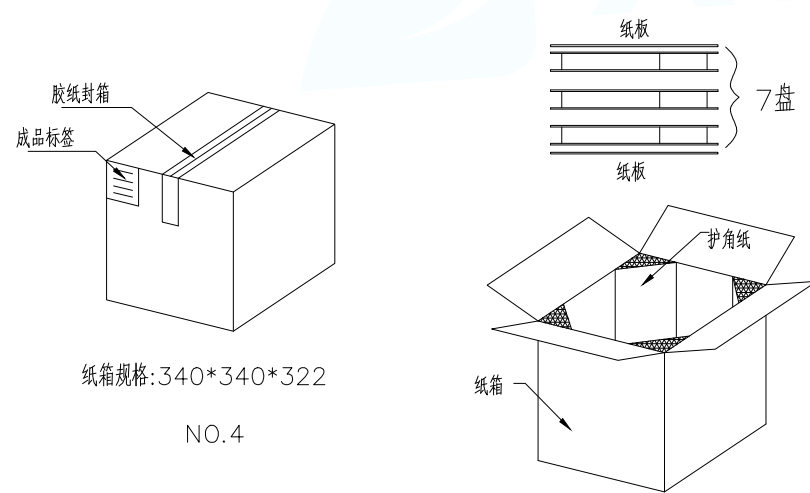
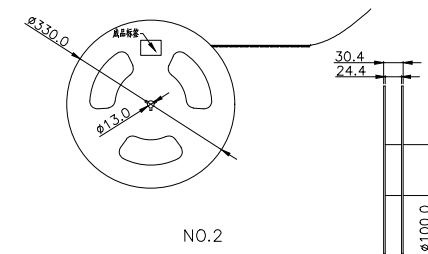
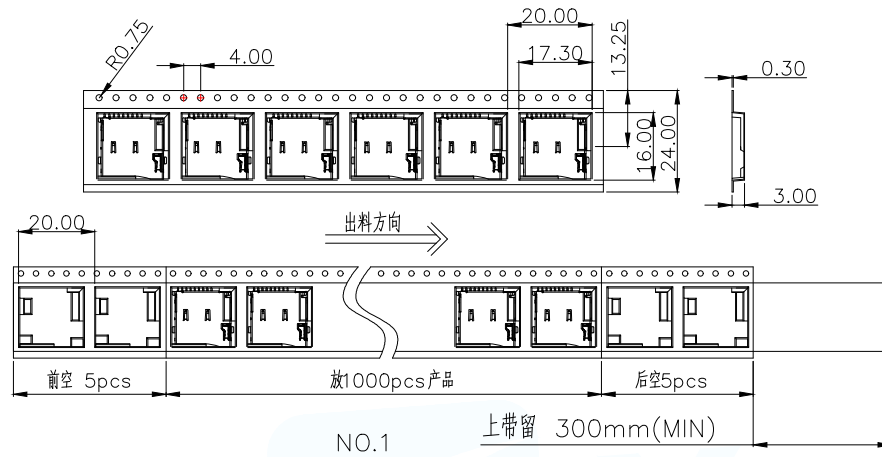
Specification:

- Electrical Characteristics:
  - Contact Current Rating:0.5 Amperes.
  - Dielectric Withstanding Voltage:AC500V r.m.s.
  - Insulation Resistance:1000 MΩ Minimum.
  - Contact Resistance:40 mΩ Maximum.
- Environmental:
  - Operating Temperature:-25°C~+90°C.
- Environmental:
  - Mating Cycles:5,000 Insertions.
- Mechanical Characteristics:
  - Card Push Insertion/Out Force:0.2~1.40kgf.
  - Contact Separation Force:0.20kgf Minimum.
- Material:
  - Insulator:HI-Temp Plastic UL 94V-0 Rated.
  - Contact:Copper Alloy(t=0.15mm).
  - Shell:Stainless Steel(t=0.15mm).
  - Spring:SWP.



| TF CARD PIN DEFINE |         |        |                            |
|--------------------|---------|--------|----------------------------|
| PIN NO.            | NAME    | YYPE   | DESCRIPTION                |
| 1                  | DAT2    | I/O/PP | DATE LINE(BIT2)            |
| 2                  | CD/DAT3 | I/O/PP | CARD DETECT DATE LIN(BIT3) |
| 3                  | CMD     | PP     | COMMAND RESPONSE           |
| 4                  | VDD     | S      | SUPPLY VOLTAGE             |
| 5                  | CLX     | I      | CLOCK                      |
| 6                  | VSS     | S      | SUPPLY VOLTAGE GROUND      |
| 7                  | DAT0    | I/O/PP | DATE LINE(BIT0)            |
| 8                  | DAT1    | I/O/PP | DATE LINE(DIT1)            |

|                                       |           |                                                     |                                                    |
|---------------------------------------|-----------|-----------------------------------------------------|----------------------------------------------------|
| MANUFACTURE DWG                       |           | 东莞市讯普电子科技有限公司<br>DongGuan XunPu Electronics Co.,Ltd |                                                    |
| UNLESS OTHERWISE SPECIFIED TOLERANCES |           |                                                     | TITLE:MICRO SD CARD PUSH<br>PUSH SMT 镀金 外焊 自弹式 双弹片 |
| DECIMALS:                             | ANGLES:   |                                                     | PAR TF-115YY-ACP9                                  |
| X.X:±0.35                             | X.X':±3°  |                                                     | DWN                                                |
| X.XX:±0.25                            | X.XX':±2° |                                                     | CHKD                                               |
| X.XXX:±0.15                           |           | APVD                                                | SCALE:1:1 UNIT:MM                                  |
| CUSTOMER COPY                         |           | SIZE:A4                                             | SHEET:1F1                                          |
|                                       |           |                                                     | REV:A                                              |



1. 材质要求:

- 1.1 纸箱的材质为K=K;外形尺寸为34\*34\*32.2;
- 1.2 卷盘的材质为PS,卷盘的外形尺寸为 $\phi 330 \times 30.4$ ;

2. 包装方式:

- 2.1 将卷带放入包装机后,前空5PCS,后放产品1000PCS,再后空5PCS;上带留300MM长度。
- 2.2 将包装好的产品从包装机上取下并包装好,贴上内盘标签;
- 2.3 把累叠好的7盘叠放入纸箱中共计7Kset,上下放纸板;
- 2.4 把包装好的成品打包封箱,并在纸箱外贴上标签

|                                       |           |                                                                                                                                           |                                                 |
|---------------------------------------|-----------|-------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------|
| MANUFACTURE DWG                       |           |  东莞市讯普电子科技有限公司<br>DongGuan XunPu Electronics Co.,Ltd |                                                 |
| UNLESS OTHERWISE SPECIFIED TOLERANCES |           |                                                      | TITLE:MICRO SD CARD PUSH PUSH SMT 镀金 外焊 自弹式 双弹片 |
| DECIMALS:                             | ANGLES:   |                                                                                                                                           | PAR TF-115YY-ACP9                               |
| X.X:±0.35                             | X.X':±3°  |                                                                                                                                           | DWN                                             |
| X.XX:±0.25                            | X.XX':±2° |                                                                                                                                           | CHKD                                            |
| X.XXX:±0.15                           |           | APVD                                                                                                                                      | SCALE 1:1 UNIT:MM                               |
| CUSTOMER COPY                         |           | SIZE:A4                                                                                                                                   | SHEET:1F1                                       |
|                                       |           |                                                                                                                                           | REV:A                                           |

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[H1.37](#) [MICRO SIM 7P H1.35](#) [TF-CARD H1.8 SY](#) [MICRO SIM 6P H1.35](#) [TF-CARD H1.8](#) [TF-115Y-BCP9](#) [TF-115YY-ACP9](#) [SMN-309-](#)  
[ARP6](#) [TF-115Y-ACP9](#) [TF-108-ARP10](#) [SMN-303S-ACP7](#) [SNO-14100](#) [SD-112S](#) [MUP-C7804-1](#) [KH-TF-07DT](#)